COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED.
ASSEMBLY VARIANT: [No Variations]

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<th>PCB VIEWED FROM TOP SIDE</th>
<th>BOARD #: PMP30252</th>
<th>REV: A</th>
<th>SUN REV: Not In VersionControl</th>
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PLOT NAME = Top Assembly Drawing
G Cheese : 8/21/2017 14:50:33
TEXAS INSTRUMENTS
COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED.
ASSEMBLY VARIANT: [No Variations]

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